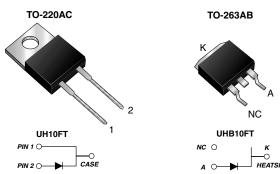


UH10FT & UHB10FT

Vishay General Semiconductor

Ultrafast Recovery Rectifier



FEATURES

- Oxide planar chip junction
- Ultrafast recovery times
- Soft recovery characteristics
- Low switching losses, high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C (for TO-263AB package)
- Solder dip 260 °C, 40 s (for TO-220AC package)
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converter and inverter for consumer.

MECHANICAL DATA

Case: TO-220AC and TO-263AB

Epoxy meets UL 94V-0 flammability rating

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD22-B102

E3 suffix for consumer grade, meets JESD 201 class 1A whisker test

Polarity: As marked

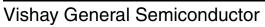
Mounting Torque: 10 in-lbs maximum

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	SYMBOL	UH10FT UHB10FT		UNIT		
Maximum repetitive peak reverse voltage	V _{RRM}	30	300			
Maximum average forward rectified current (Fig. 1)	I _{F(AV)}	10		А		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	180		А		
Operating junction and storage temperature range	T _J , T _{STG}	- 55 to + 175		°C		

NC • Meets MSI peak of 24: • Solder dip • Componen and WEEE

PRIMARY CHARACTERISTICS				
I _{F(AV)}	10 A			
V _{RRM}	300 V			
I _{FSM}	180 A			
t _{rr}	25 ns			
V _F	0.83 V			
T _J max.	175 °C			

UH10FT & UHB10FT





ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT	
Maximum instantaneous forward voltage ⁽¹⁾	l _F = 5.0 A l _F = 5.0 A	T _J = 25 °C T _J = 125 °C	V _F	0.96 0.77	-	v	
	I _F = 10 A I _F = 10 A	T _J = 25 °C T _J = 125 °C		1.0 0.83	1.2 0.90		
Maximum reverse current (2)	V _R = 300 V	T _J = 25 °C T _J = 125 °C	I _R	0.5 25	5 150	μΑ	
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	20	25	ns	
Maximum reverse recovery time	$I_F = 1.0 \text{ A}, \text{ dI/dt} = 50 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}, I_{rr} = 0.1 I_{RM}$		t _{rr}	28	35	ns	
Typical softness factor (tb/ta)	I _F = 10 A, dl/dt = 200 A/μs, V _R = 200 V, T _J = 125 °C		S	0.36	-	-	
Typical reverse recovery current			I _{RM}	7.0	-	ns	
Typical stored charge			Q _{rr}	160	-	А	
Typical forward recovery time	$I_F = 10$ A, dl/dt = 80 A/µs, $V_{FR} = 1.1$ x $V_{F max.}$		t _{fr}	150	-	ns	

Notes:

(1) Pulse test: 300 μs pulse width, 1 % duty cycle

(2) Pulse test: Pulse width \leq 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	UH10FT	UHB10FT	UNIT		
Typical thermal resistance	$R_{ ext{ heta}JC}$	2.0	2.0	°C/W		

ORDERING INFORMATION (Example)						
PACKAGE	PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
TO-220AC	UH10FT-E3/4W	1.82	4W	50/tube	Tube	
TO-263AB	UHB10FT-E3/4W	1.32	4W	50/tube	Tube	
TO-263AB	UHB10FT-E3/8W	1.32	8W	800/reel	Tape and reel	



100

10

0.1

Instantaneous Forward Current (A)

UH10FT & UHB10FT

25 °C

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RATINGS AND CHARACTERISTICS CURVES

 $(T_A = 25 \circ C \text{ unless otherwise noted})$

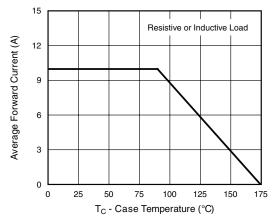


Figure 1. Maximum Forward Current Derating Curve

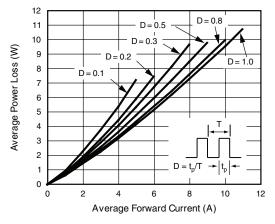


Figure 2. Forward Power Loss Characteristics

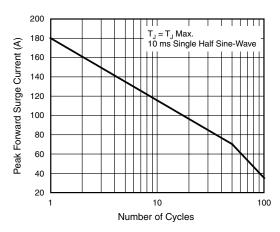
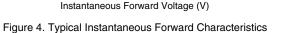


Figure 3. Maximum Non-Repetitive Peak Forward Surge Current

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For technical questions within your region, please contact one of the following: PDD-Americas@vishay.com, PDD-Asia@vishay.com, PDD-Europe@vishay.com



0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1.0 1.1 1.2 1.3 1.4 1.5

125 °C

= 175 °C

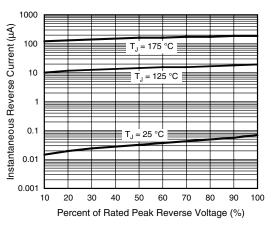


Figure 5. Typical Reverse Leakage Charactersitics

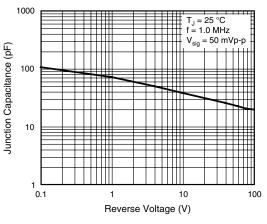
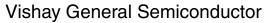
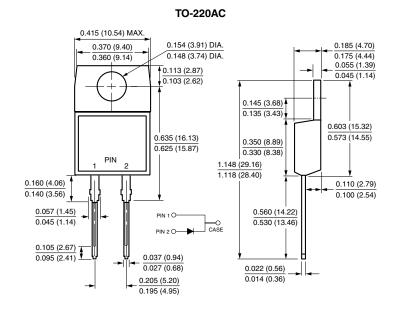


Figure 6. Typical Junction Capacitance

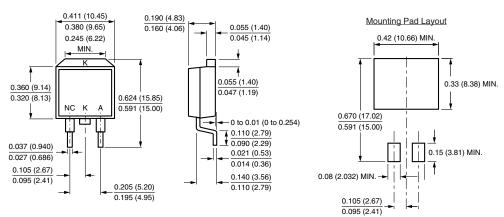
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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



TO-263AB





VISHA`



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